

Fig. 1 is a cross-sectional view of a substrate 30. The substrate 30 has a top surface 31. A layer 6 is formed on the surface 31. This layer 6 contains a series of circular openings 30. Some of these openings are filled with a cross-hatched material 60, while others are empty.

This diagram shows a cross-sectional view of a multi-layered electronic device assembly. The assembly consists of several distinct layers and components, labeled with reference numerals:

- 18**: A topmost thin layer.
- 19**: A thick, dark, textured layer below 18.
- 20**: A layer containing a series of small, rounded, protruding elements.
- 21**: A layer below 20, featuring a series of vertical, rectangular protrusions.
- 13**: A layer below 21, containing a series of small, rectangular protrusions.
- 12**: A layer below 13, containing a series of small, rectangular protrusions.
- 90**: A layer below 12, containing a series of small, rectangular protrusions.
- 8**: A layer below 90, containing a series of small, rectangular protrusions.
- 5**: A layer below 8, containing a series of small, rectangular protrusions.
- 1**: A central layer with a cross-hatched pattern.
- 6**: A layer below 1, containing a series of small, rectangular protrusions.
- 4**: A layer below 6, containing a series of small, rectangular protrusions.
- 10**: A layer below 4, containing a series of small, rectangular protrusions.
- 11**: A bottom layer containing a series of small, rectangular protrusions.
- 16**: A bracketed group of layers 14 and 15.
- 15**: A layer within the bracketed group 16.
- 14**: A layer within the bracketed group 16.
- 17**: A layer below 14, containing a series of small, rectangular protrusions.

FIG. 4

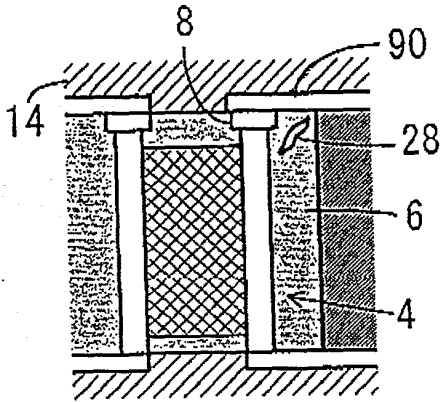


FIG. 5

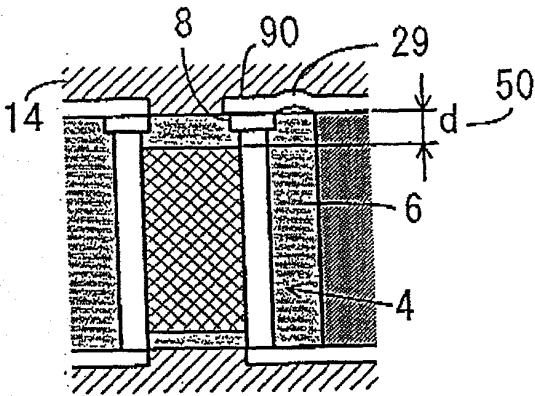


FIG. 6

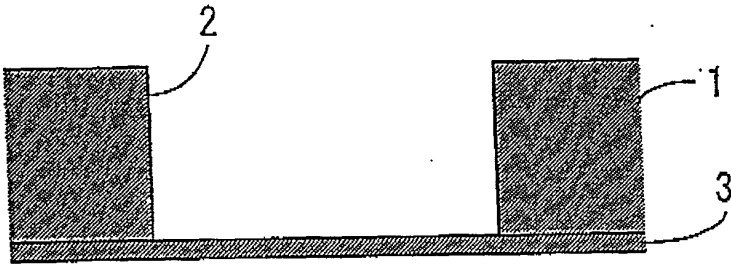


FIG. 7

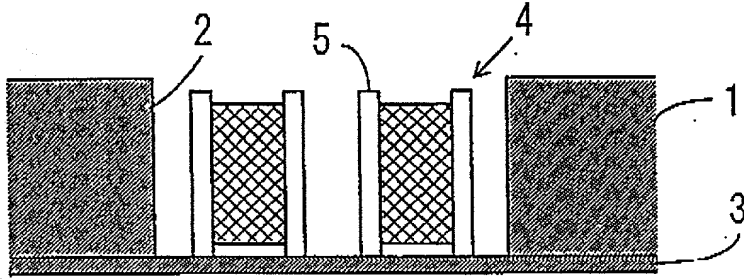


FIG. 8-

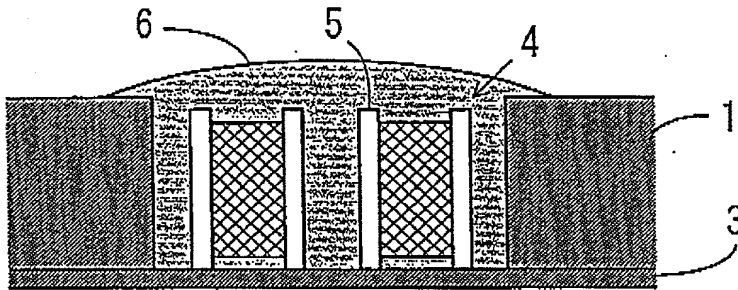
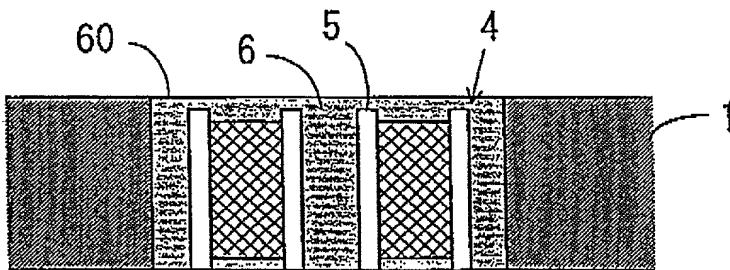


FIG. 9



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FIG. 10

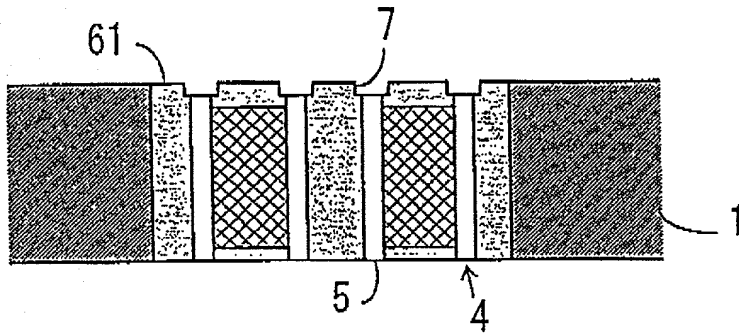


FIG. 11

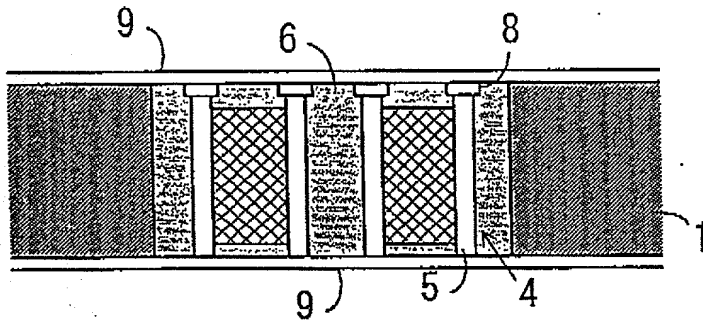
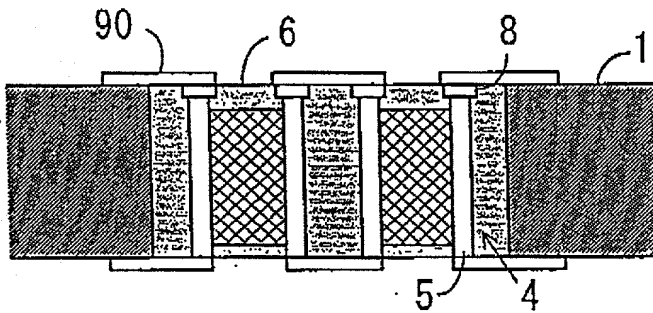
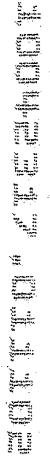


FIG. 12



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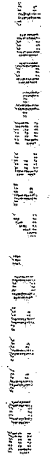


FIG. 15

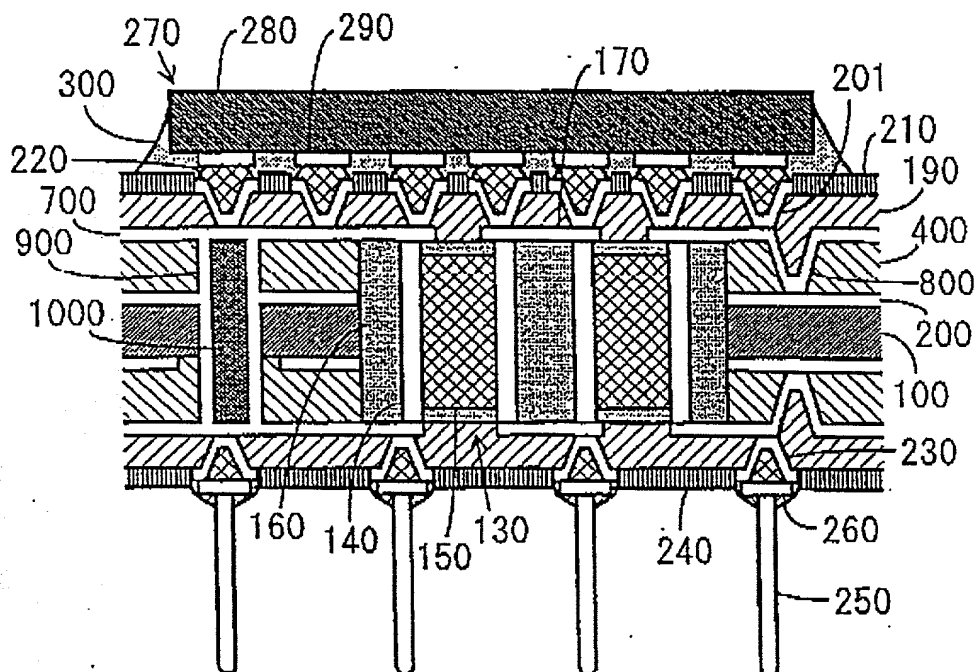


FIG. 16

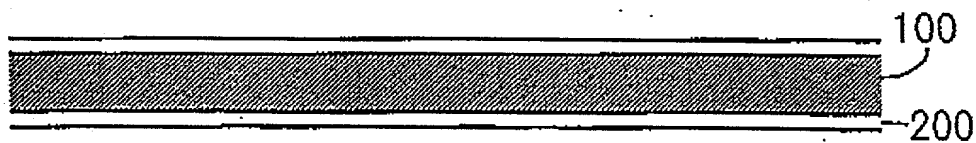


FIG. 17

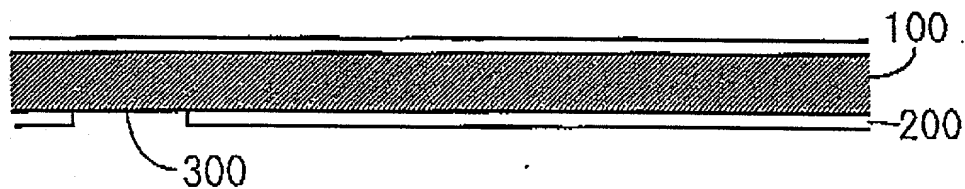


FIG. 18

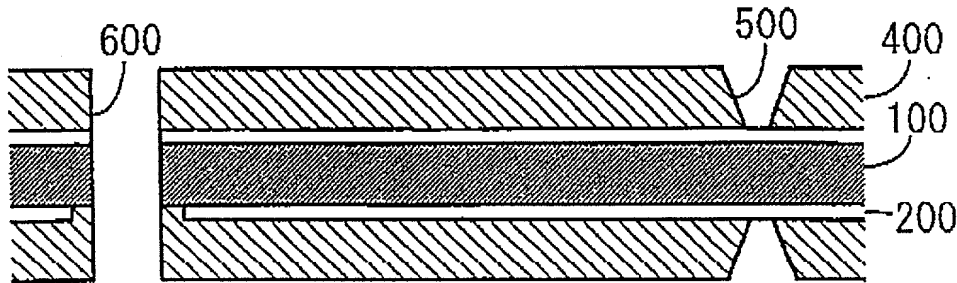


FIG. 19

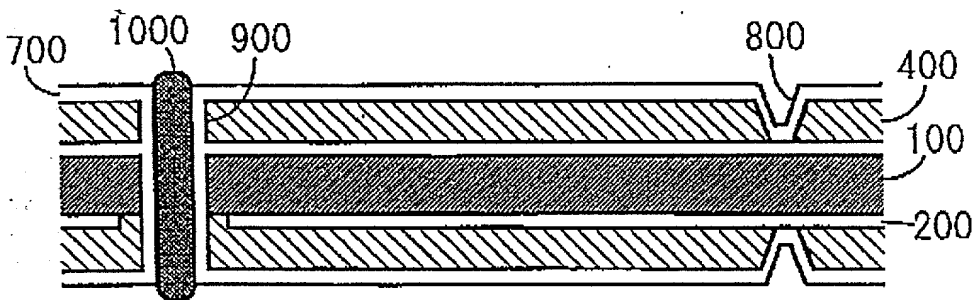


FIG. 20

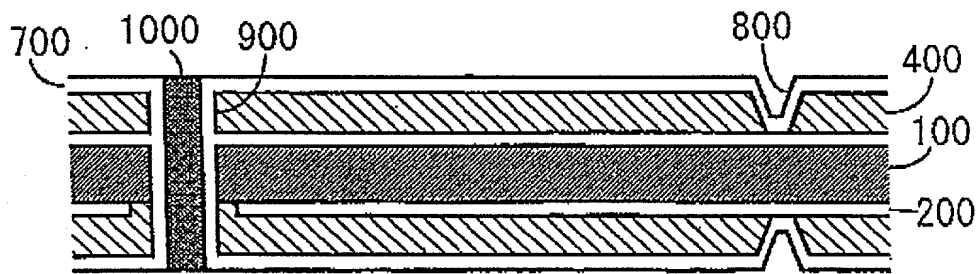


FIG. 21

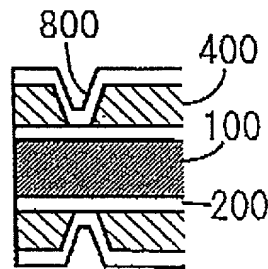
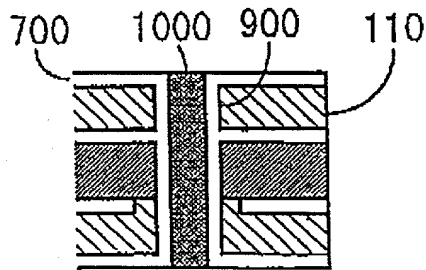


FIG. 22

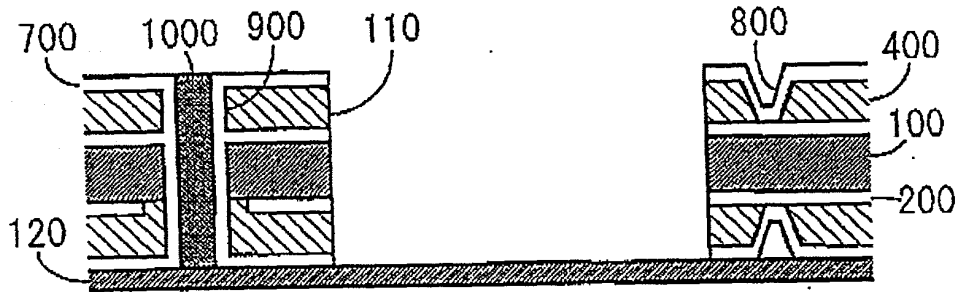


FIG. 23

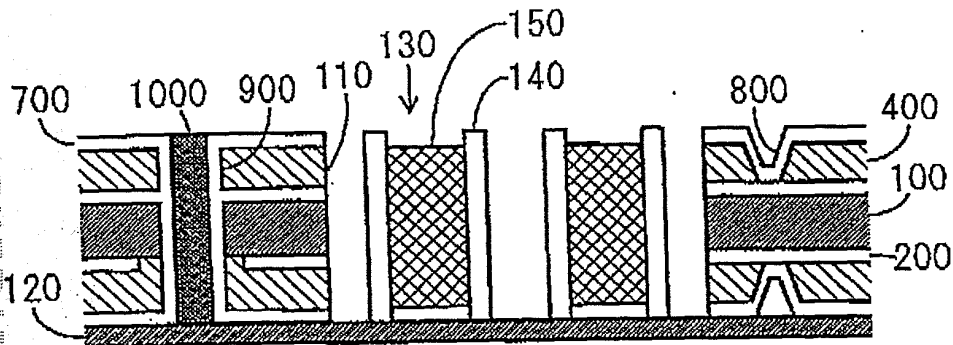


FIG. 24

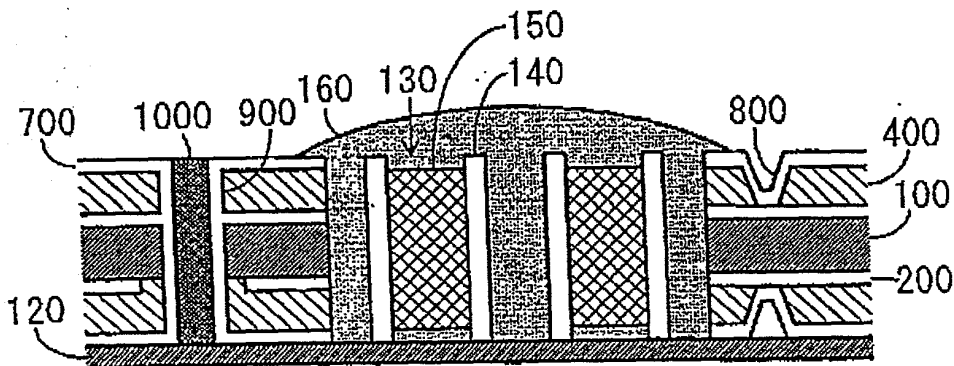


FIG. 25

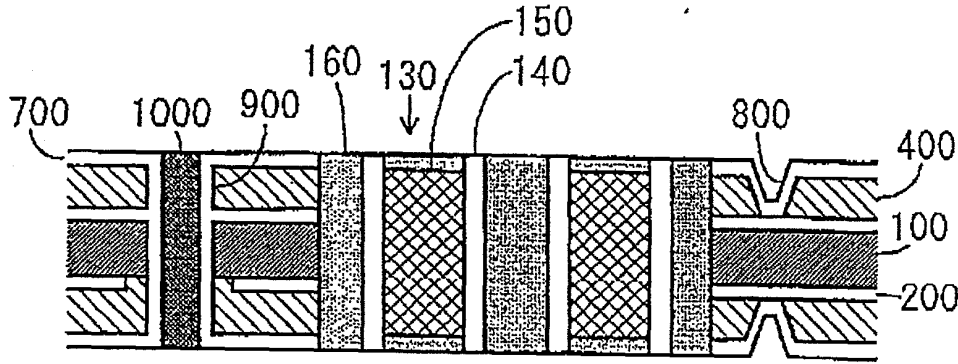


FIG. 26

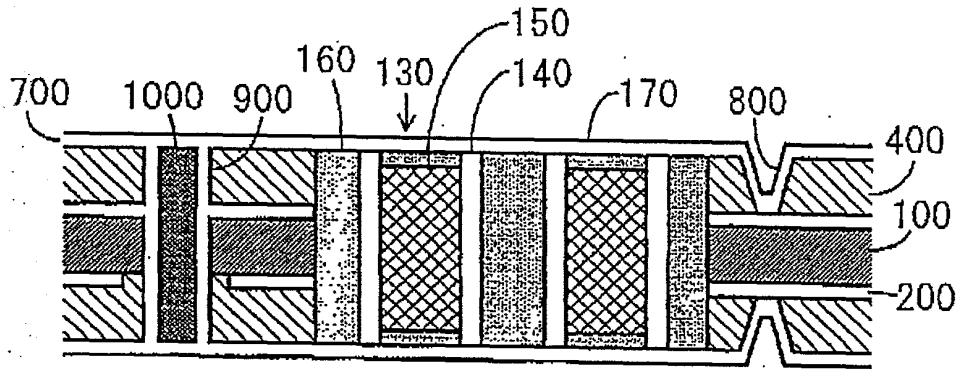


FIG. 27

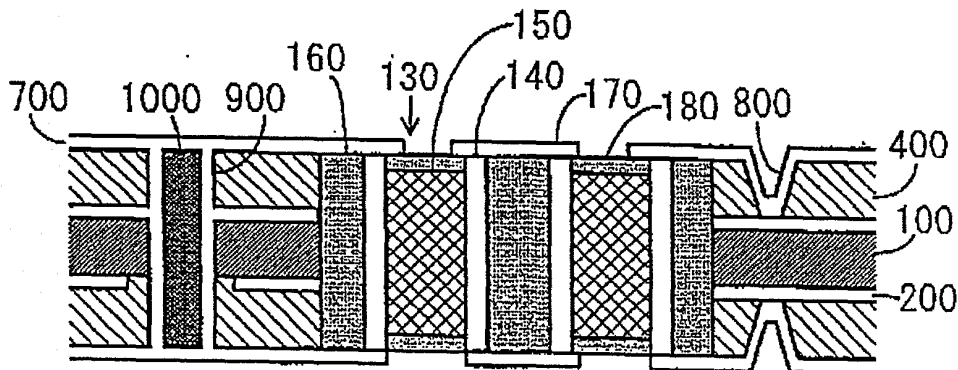


FIG. 25

FIG. 28

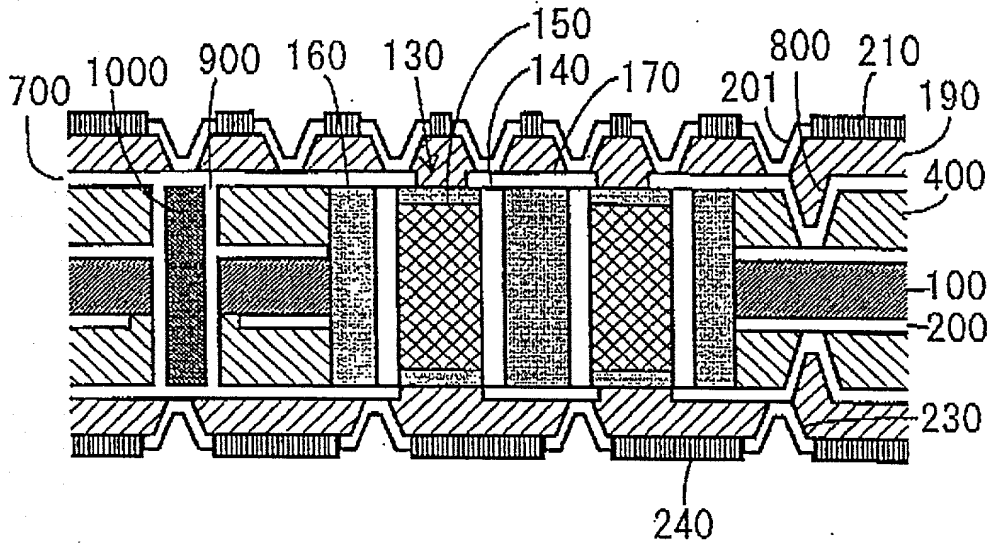


FIG. 29

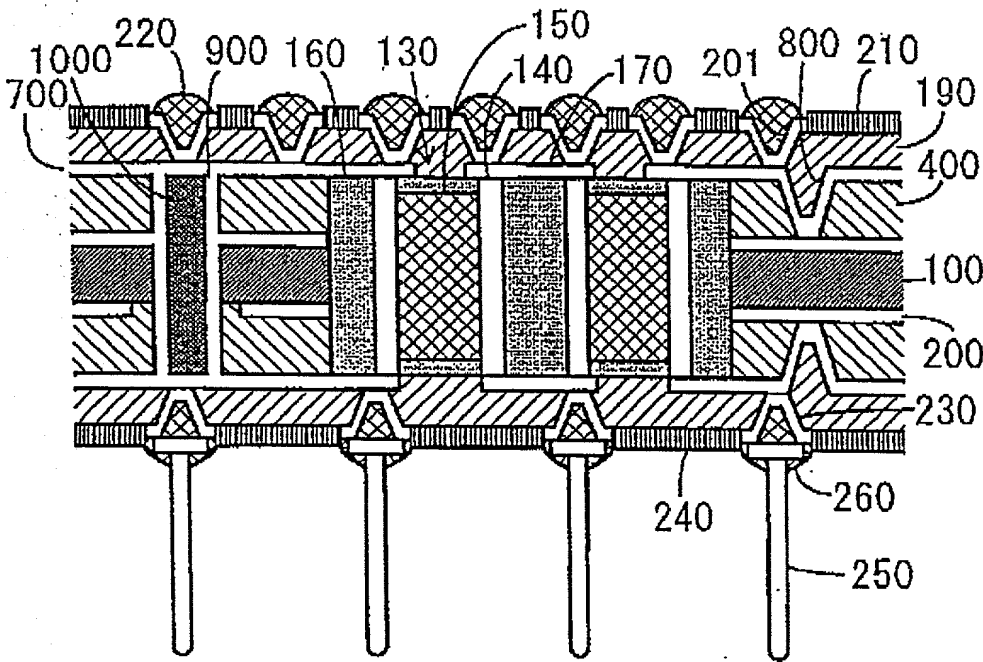


FIG. 28